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November 2013

FQPF20N06L

N-Channel QFET[®] MOSFET 60 V, 15.7 A, 55 m Ω

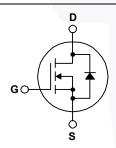
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 15.7 A, 60 V, $R_{DS(on)}$ = 55 m Ω (Max.) @ V_{GS} = 10 V, I_D = 7.85 A
- Low Gate Charge (Typ. 9.5 nC)
- Low Crss (Typ. 35 pF)
- · 100% Avalanche Tested
- · 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQPF20N06L	Unit
$V_{\rm DSS}$	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°	C)	15.7	Α
	- Continuous (T _C = 100)°C)	11.1	А
I _{DM}	Drain Current - Pulsed	(Note 1)	62.8	Α
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	170	mJ
I _{AR}	Avalanche Current	(Note 1)	15.7	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P_{D}	Power Dissipation (T _C = 25°C)		30	W
	- Derate above 25°C		0.2	W/°C
T _J , T _{STG}	Operating and Storage Temperature Ran	nge	-55 to +175	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQPF20N06L	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	5.00	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQPF20N06L	FQPF20N06L	TO-220F	Tube	N/A	N/A	50 units

Fle	ctrical	l Chara	cter	istics
	Cuica	ı Cılala	CLEI	SHE

T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.06		V/°C
I _{DSS}	Zara Oata Valtaria Daria Orinnat	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 48 V, T _C = 150°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
/						
On Cha	racteristics					

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		2.5	V
R _{DS(on)}	Static Drain-Source	$V_{GS} = 10 \text{ V}, I_D = 7.85 \text{ A}$	-	0.042	0.055	0
	On-Resistance	$V_{GS} = 5 V, I_D = 7.85 A$		0.055	0.07	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 25 V, I _D = 7.85 A		9		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,	 480	630	pF
Coss	Output Capacitance	f = 1.0 MHz	 175	230	pF
C _{rss}	Reverse Transfer Capacitance		 35	45	pF

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	V _{DD} = 30 V, I _D = 10.5 A,		10	30	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		165	340	ns
t _{d(off)}	Turn-Off Delay Time			35	80	ns
t _f	Turn-Off Fall Time	(Note 4)	/	70	150	ns
Qg	Total Gate Charge	V _{DS} = 48 V, I _D = 21 A,	-	9.5	13	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V		2.5		nC
Q_{gd}	Gate-Drain Charge	(Note 4)		5.5		nC

Drain-Source Diode Characteristics and Maximum Ratings

I_S	Maximum Continuous Drain-Source Diode Forward Current		 	15.7	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		 	62.8	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 15.7 A	 	1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, I}_{S} = 21 \text{ A,}$	 54		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs	 75		nC

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature. 2. L = 800 μ H, I_{AS} = 15.7 A, V_{DD} = 25 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} \leq 21 A, di/dt \leq 300 A/ μ s, V_{DD} \leq BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature.

Typical Characteristics

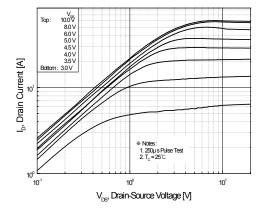


Figure 1. On-Region Characteristics

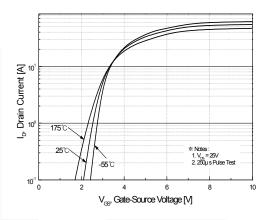


Figure 2. Transfer Characteristics

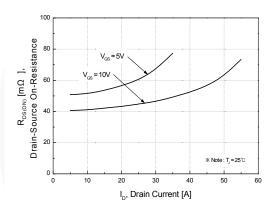


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

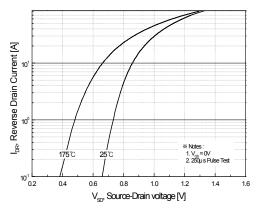


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

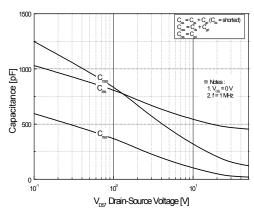


Figure 5. Capacitance Characteristics

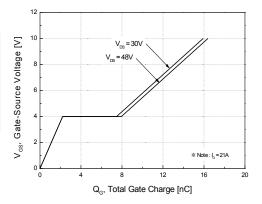
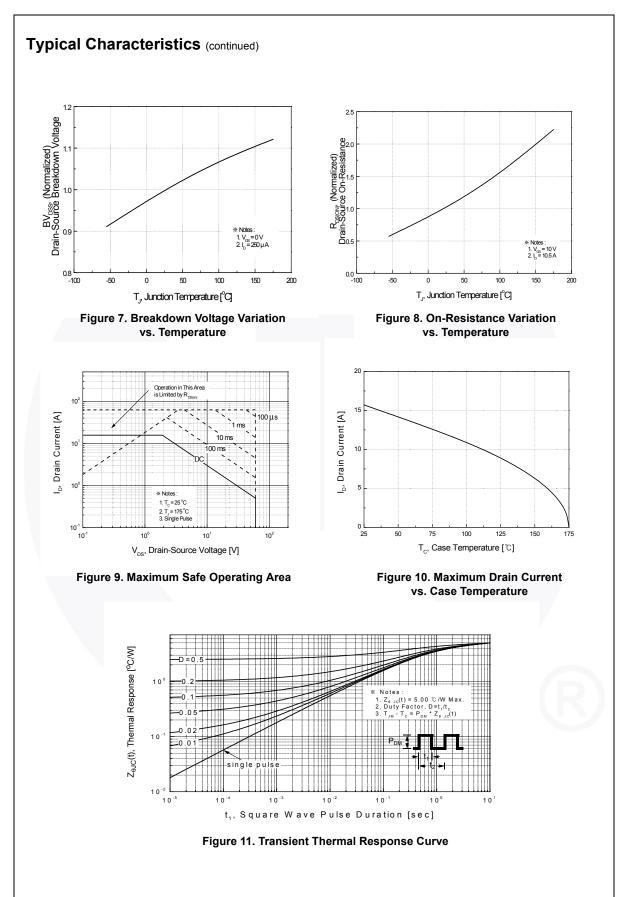


Figure 6. Gate Charge Characteristics



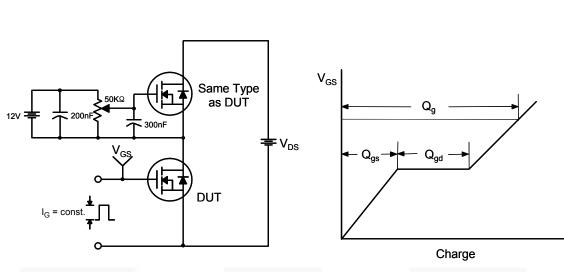
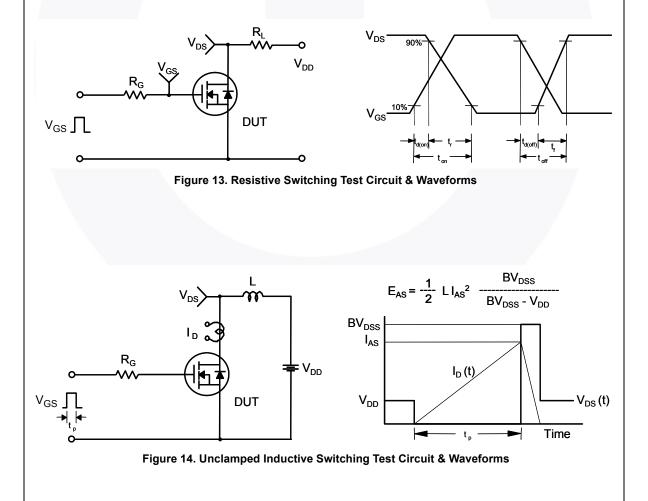
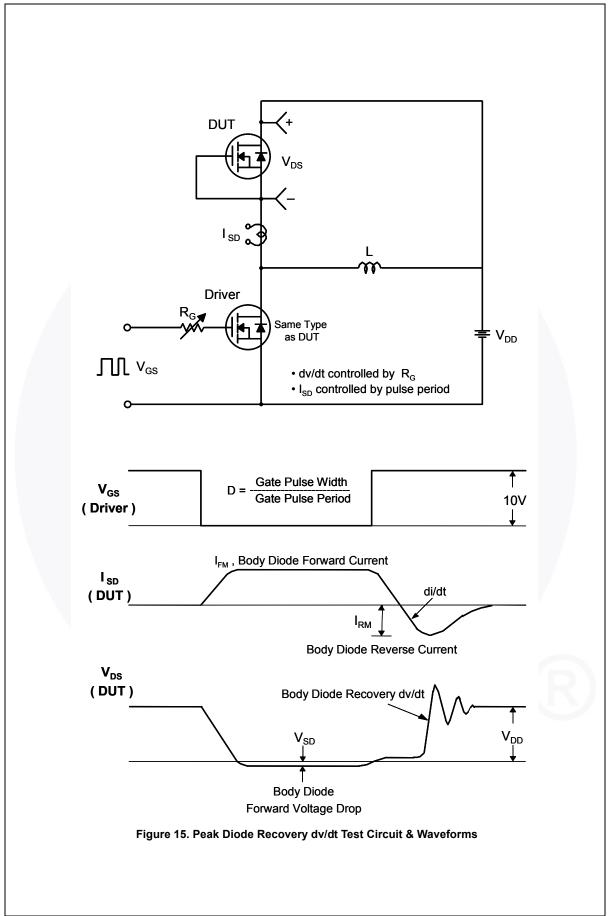


Figure 12. Gate Charge Test Circuit & Waveform





Mechanical Dimensions

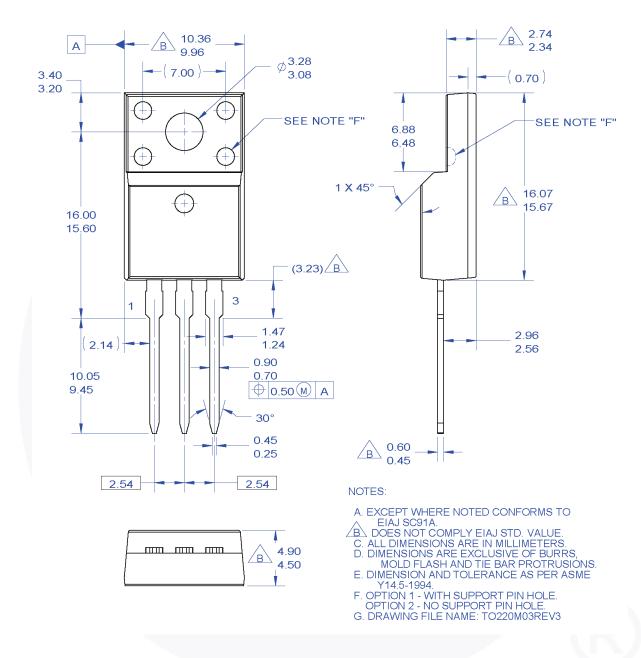


Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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